

FQPF27N25 250V N-Channel MOSFET

General Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switching DC/DC converters, switch mode power supply.

Features

- 14A, 250V, $R_{DS(on)}$ = 0.11 Ω @V_{GS} = 10 V Low gate charge (typical 50 nC)
- Low Crss (typical 45 pF)
- Fast switching
- · 100% avalanche tested
- · Improved dv/dt capability





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		FQPF27N25	Units
V _{DSS}	Drain-Source Voltage		250	V
I _D	Drain Current - Continuous (T _C = 25°C)		14	A
	- Continuous (T _C = 100°C)		8.9	A
I _{DM}	Drain Current - Pulsed	(Note 1)	56	A
V _{GSS}	Gate-Source Voltage		± 30	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	600	mJ
I _{AR}	Avalanche Current	(Note 1)	14	A
E _{AR}	Repetitive Avalanche Energy	(Note 1)	5.5	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	5.5	V/ns
PD	Power Dissipation (T _C = 25°C)		55	W
	- Derate above 25°C		0.44	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

Thermal Characteristics

Symbol	Parameter	Тур	Max	Units
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case		2.27	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient		62.5	°C/W

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ТМ

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Cha	aracteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA	250			V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu A$, Referenced to $25^{\circ}C$;	0.29		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 250 V, V _{GS} = 0 V			1	μA
		V _{DS} = 200 V, T _C = 125°C			10	μA
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30 V, V _{DS} = 0 V			-100	nA
				1		
	Gate Threshold Voltage	$V_{\text{DO}} = V_{\text{OO}}$ $I_{\text{D}} = 250 \mu\text{A}$	3.0		5.0	V
RDS(m)	Static Drain-Source		0.0		0.0	v
NDS(on)	On-Resistance	V _{GS} = 10 V, I _D = 7.0 A		0.083	0.11	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 50 V, I _D = 7.0 A (Note 4)	15		S
Dynam	ic Characteristics	Ι	_	4000	0.450	
C _{iss}		V _{DS} = 25 V, V _{GS} = 0 V,		1900	2450	p⊦
Coss		f = 1.0 MHz		360	470	p⊦
C _{rss}	Reverse Transfer Capacitance			45	60	р⊦
Switchi	ing Characteristics					
t _{d(on)}	Turn-On Delay Time	$V_{} = 125 V_{} = 27 A_{}$		32	75	ns
t _r	Turn-On Rise Time	$V_{DD} = 123 V, I_D = 27 A,$ $R_0 = 25 \Omega$		270	550	ns
t _{d(off)}	Turn-Off Delay Time	- 10 - 20 - 20 - 20		80	170	ns
t _f	Turn-Off Fall Time	(Note 4, 5	5)	120	250	ns
Q _g	Total Gate Charge	V _{DS} = 200 V. I _D = 27 A.		50	65	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = 10 V$		12.5		nC
Q _{gd}	Gate-Drain Charge	(Note 4, 5	j)	26		nC
	•					
Drain-S	ource Diode Characteristics a	nd Maximum Ratings				
I _S	Maximum Continuous Drain-Source Diode Forward Current				14	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current				56	A
V _{SD}	Drain-Source Diode Forward Voltage $V_{GS} = 0 V$, $I_S = 14 A$				1.5	V

 V_{GS} = 0 V, I_S = 27 A,

 dI_F / dt = 100 A/µs

(Note 4)

220

1.8

ns

μC

 Q_{rr}

t_{rr}

Notes: 1. Repetitive Rating : Pulse width limited by maximum junction temperature 2. L = 4.9mH, I_{AS} = 14A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C 3. I_{SD} \leq 27A, di/dt \leq 300A/µs, V_{DD} \leq BV_{DSS}, Starting T_J = 25°C 4. Pulse Test : Pulse width \leq 300µs, Duty cycle \leq 2% 5. Essentially independent of operating temperature

Reverse Recovery Time

Reverse Recovery Charge

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